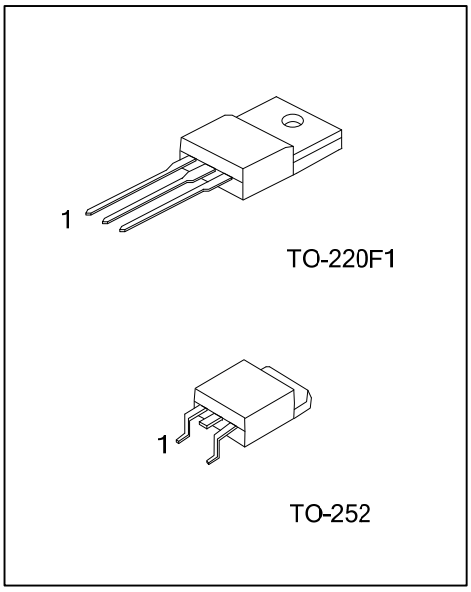
UPGE10N60

Insulated Gate Bipolar Transistor

600V, SMPS N-CHANNEL IGBT



■ DESCRIPTION

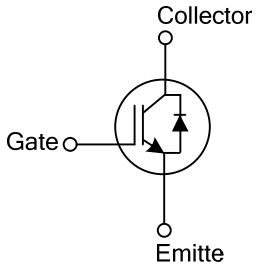
The UTC **UPGE10N60** is a N-channel IGBT. it uses UTC's advanced technology to provide customers with high input impedance, high switching speed and low conduction loss, etc.

The UTC **UPGE10N60** is suitable for high voltage switching, high frequency switch mode power supplies.

■ FEATURES

* $V_{CE(SAT)}$ ≤ 1.95V @ I_C=20A, V_{GE}=15V
* High switching speed
* High input impedance
* Low conduction loss

■ SYMBOL



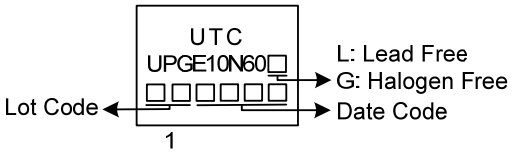
■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
UPGE10N60L-TF1-T	UPGE10N60G-TF1-T	TO-220F1	G	C	E	Tube
UPGE10N60L-TN3-R	UPGE10N60G-TN3-R	TO-252	G	C	E	Tape Reel

Note: Pin Assignment: G: Gate C: Collector E: Emitter

UPGE10N60G-TF1-T (1)Packing Type (2)Package Type (3)Green Package	(1) T: Tube, R: Tape Reel (2) TF1: TO-220F1, TN3: TO-252 (3) G: Halogen Free and Lead Free, L: Lead Free

■ MARKING



■ ABSOLUTE MAXIMUM RATINGS (T_C=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Collector-Emitter Voltage		V_{CES}	600	V
Gate to Emitter Voltage Continuous		V_{GES}	±20	V
Continuous Collector Current	T_C=25°C	I_C	20	A
	T_C=100°C		10	A
Collector Current Pulsed (Note 2)		I_{CM}	30	A
Continuous Forward Current	T_C=25°C	I_F	10	A
	T_C=100°C		5	A
Forward Current Pulsed		I_{FM}	80	A
Peak Diode Recovery dv/dt (Note 3)		dv/dt	6.8	V/ns
Power Dissipation	TO-220F1	P_D	28	W
	TO-252		40	W
Junction Temperature		T_J	-55 ~ +150	°C
Storage Temperature Range		T_{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.
2. Repetitive Rating: Pulse width limited by maximum junction temperature.
3. I_F ≤10A, di/dt ≤200A/μs, V_{CC} ≤ BV_{CES}, Starting T_J=25°C

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Case	TO-220F1	θ_{JC}	4.46	°C/W
	TO-252		3.12	°C/W

■ ELECTRICAL CHARACTERISTICS (T_J=25°C, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS		MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Collector-Emitter Breakdown Voltage	BV_{CES}	I_C=250μA, V_{GE}=0V		600			V
Collector-Emitter Leakage Current	I_{CES}	V_{CE}=600V, V_{GE}=0V				10	μA
Gate to Emitter Leakage Current	I_{GES}	V_{CE}=0V, V_{GE}=±20V				±400	nA
ON CHARACTERISTICS							
Collector-Emitter Saturation Voltage	$V_{CE(SAT)}$	I_C=10A, V_{GE}=15V	T_J=25°C		1.6	1.95	V
			T_J=150°C		1.7		V
Gate to Emitter Threshold Voltage	$V_{GE(TH)}$	I_C=250μA, V_{CE}=V_{GE}		4.0		6.5	V
DYNAMIC CHARACTERISTICS							
Input Capacitance	C_{IES}	V_{CE}=30V, V_{GE}=0V, f=1MHz			418		pF
Output Capacitance	C_{OES}				53		pF
Reverse Transfer Capacitance	C_{RES}				8.9		pF
SWITCHING CHARACTERISTICS							
Total Gate Charge	Q_G	I_C=10A, V_{CE}=100V, V_{GE}=10V			15		nC
Gate-Emitter Charge	Q_{GE}				4.5		nC
Gate-Collector Charge	Q_{GC}				6		nC
Current Turn-On Delay Time	$t_{D(ON)}$	I_C=10A, V_{CE}=50V, V_{GE}=15V, R_G=10Ω			64		ns
Current Rise Time	t_R				46		ns
Current Turn-Off Delay Time	$t_{D(OFF)}$				56		ns
Current Fall Time	t_F				45		ns
DRAIN-SOURCE DIODE CHARACTERISTICS							
Forward Voltage Drop	V_{FM}	I_F=4A				2.6	V
Reverse Recovery Time	t_{rr}	I_F=4A, dI/dt=100A/μS, V_{CC}=400V			66		ns
Reverse Recovery Charge	Q_{rr}				140		nC

Note: Pulse Test: Pulse width≦50μs.

■ TEST CIRCUIT AND WAVEFORMS

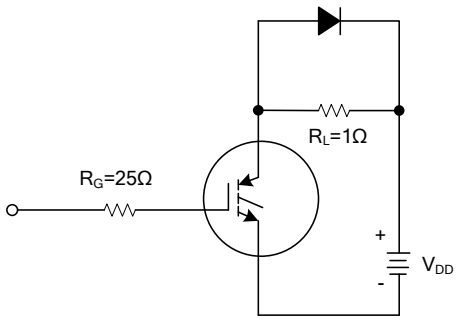


Fig 1. INDUCTIVE SWITCHING TEST CIRCUIT

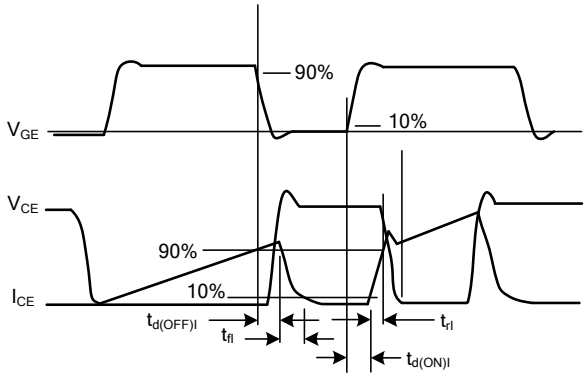
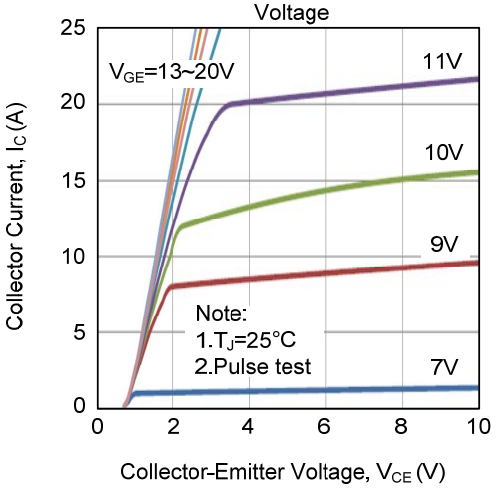


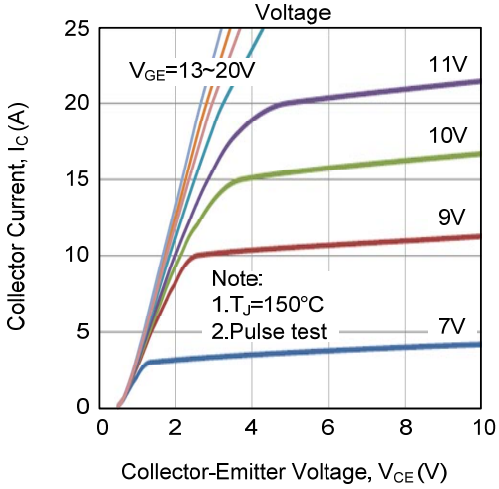
Fig 2. SWITCHING TEST WAVEFORMS

■ TYPICAL CHARACTERISTICS

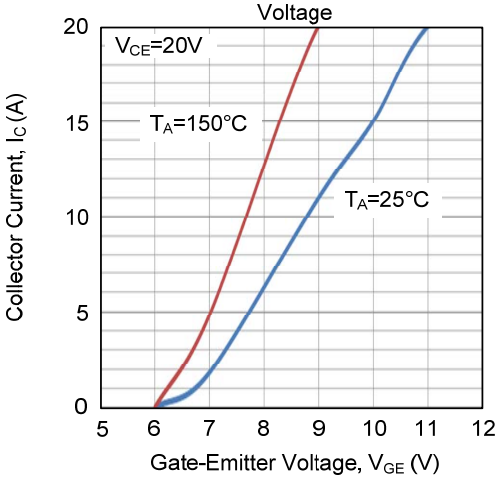
Drain Current vs. Collector-Emitter Voltage



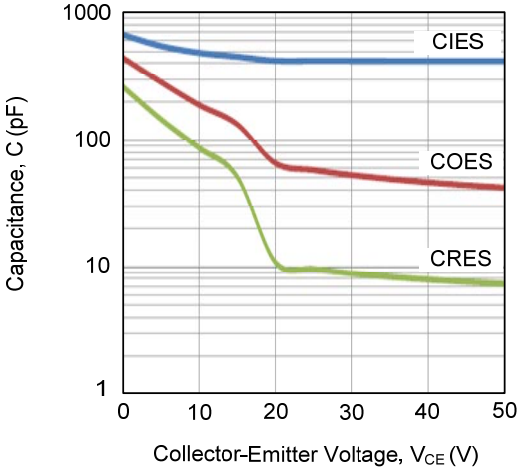
Drain Current vs. Collector-Emitter Voltage



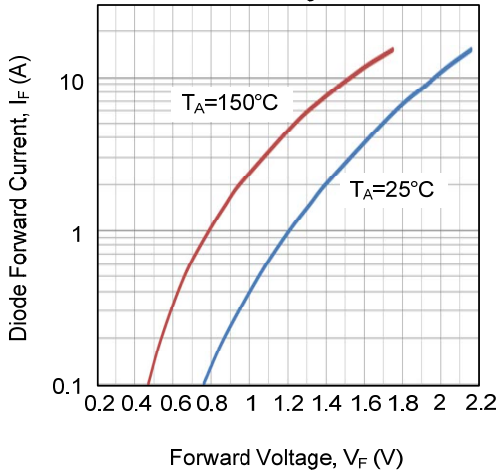
Collector Current vs. Gate-Emitter Voltage



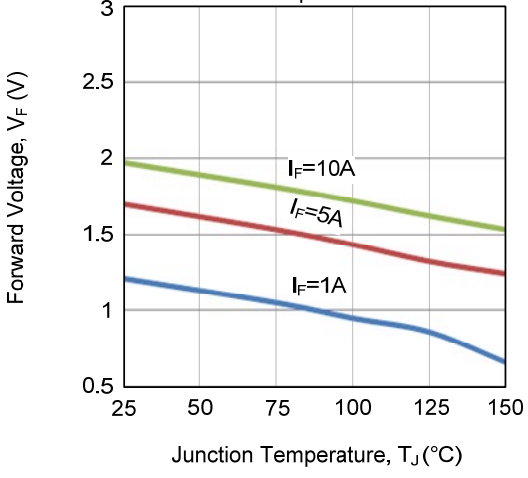
Capacitance Characteristics



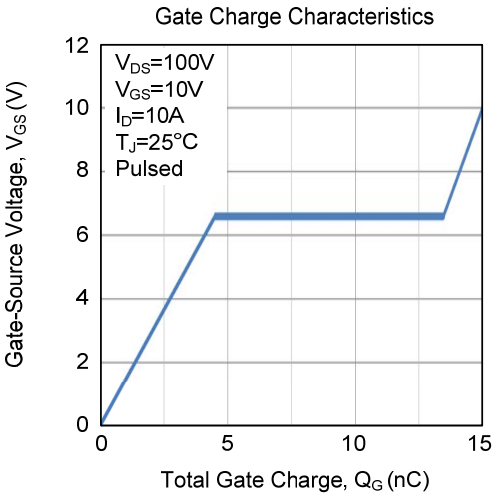
Diode Forward Current vs. Forward Voltage

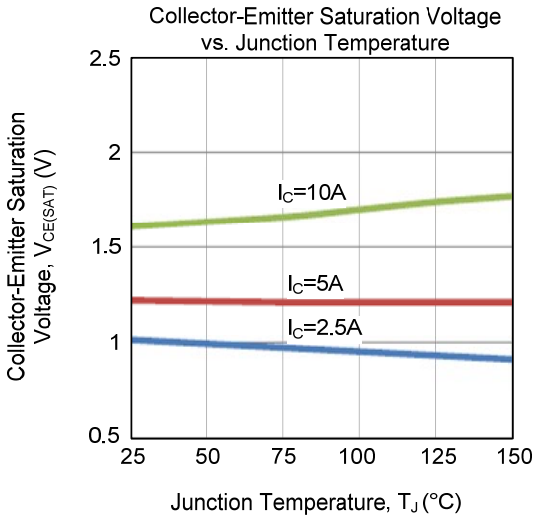


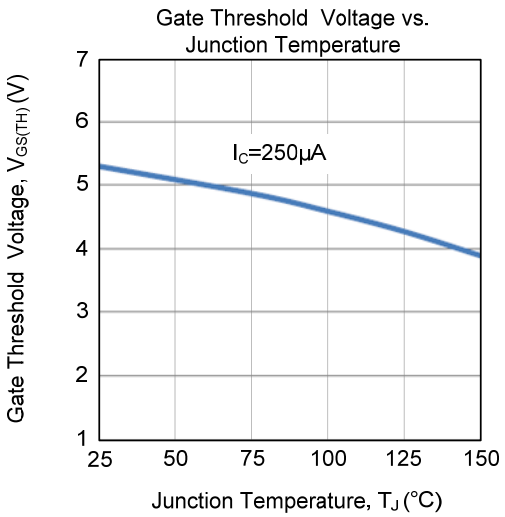
Forward Voltage vs. Junction Temperature

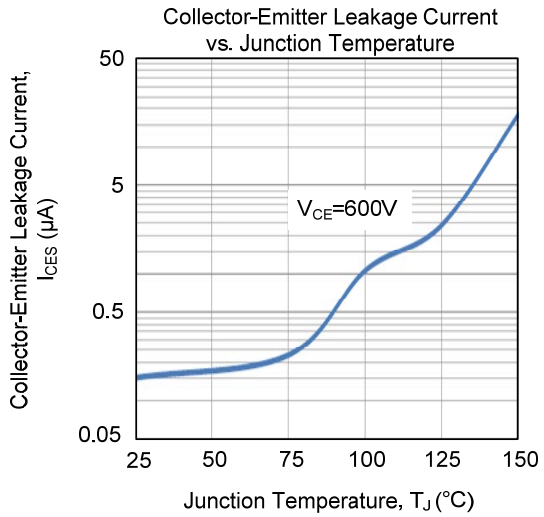


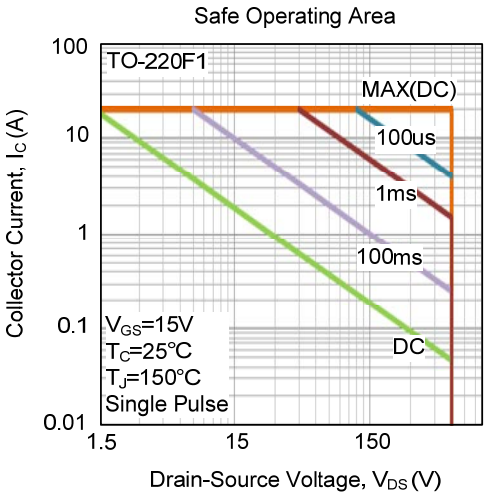
■ TYPICAL CHARACTERISTICS (Cont.)



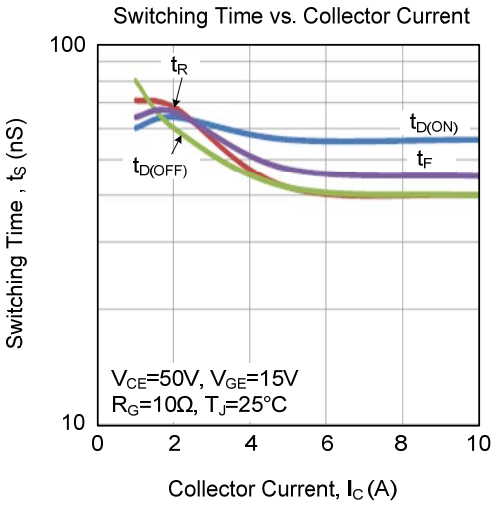


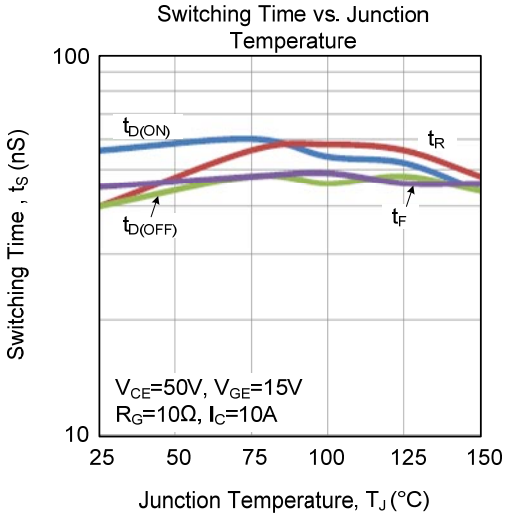


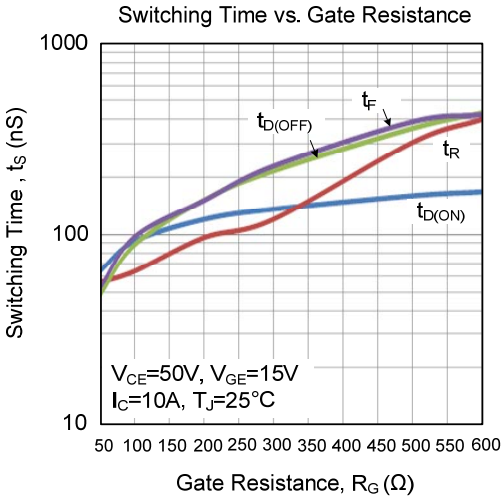


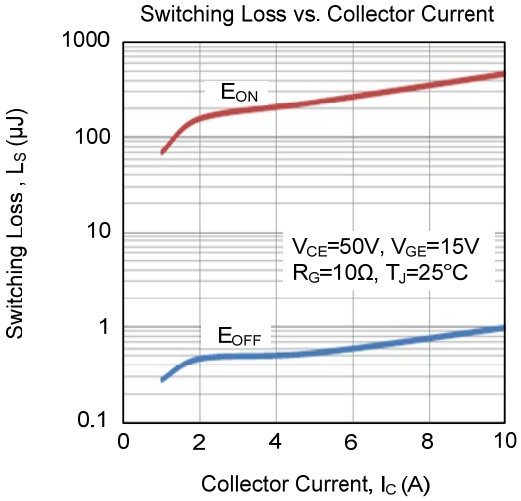


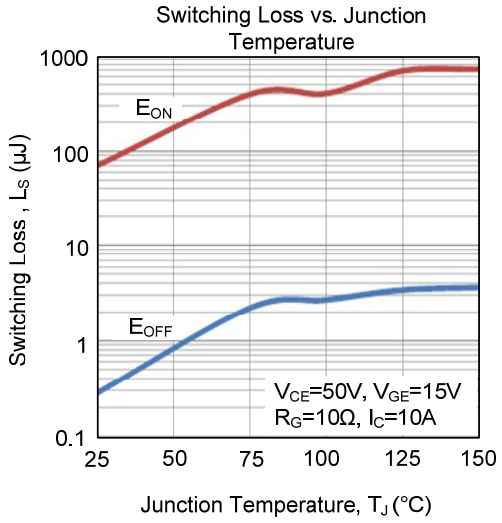
■ TYPICAL CHARACTERISTICS (Cont.)

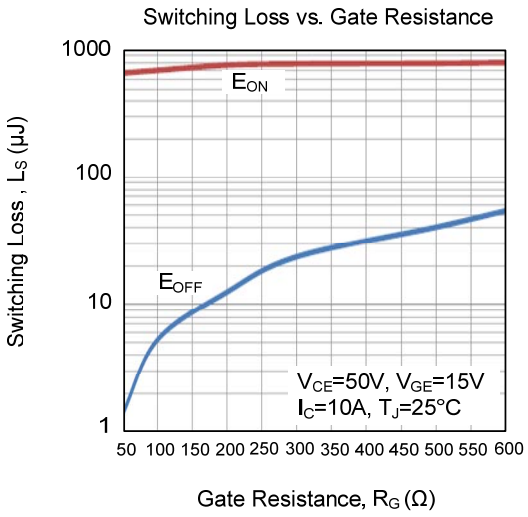












■ TYPICAL CHARACTERISTICS (Cont.)